

WHAT IS CLAIMED IS:

1. A junction flexible wiring circuit board used for performing junction between a suspension board for mounting a magnetic head thereon and a control circuit board for operating said magnetic head, said junction flexible wiring circuit board comprising:

a metal layer formed as a front surface layer of said junction flexible wiring circuit board.

2. A junction flexible wiring circuit board according to Claim 1, further comprising:

a plurality of wiring circuit patterns disposed at intervals of a predetermined distance;

wherein said metal layer is formed at least in a position opposite to said wiring circuit patterns.

3. A junction flexible wiring circuit board according to Claim 2, wherein a width of each of said wiring circuit patterns is not projected out from a width of said metal layer.

4. A junction flexible wiring circuit board according to Claim 2, wherein a width of said metal layer is formed to be not smaller than a sum of a total width of said wiring circuit patterns and a total width of intervals between said wiring circuit patterns; and

a width of each of said wiring circuit patterns is not projected out from the width of said metal layer.

5. A junction flexible wiring circuit board according to Claim 2, wherein each of said wiring circuit patterns is provided with at least one of write line and at least one of read line; and

said metal layer includes a write line side metal layer portion opposite to all of said write lines, and a read line side metal layer portion disposed at a predetermined distance from said write line side metal layer portion so as to be opposite to all of said read lines.

6. A junction flexible wiring circuit board according to Claim 5, wherein:

a width of said write line side metal layer portion is formed to be not smaller than a sum of a total width of said write lines and a total width of intervals between said write lines;

a width of each of said write lines portion is not projected out from the width of said write line side metal layer portion;

a width of said read line side metal layer portion is formed to be not smaller than a sum of a total width of said read lines and a total width of intervals between said read

lines; and

a width of each of said read lines is not projected out from a width of said read line side metal layer portion.

7 A junction flexible wiring circuit board according to Claim 1, wherein said metal layer is formed on a side of said junction flexible wiring circuit board on which a terminal portion connected to said suspension board is provided.

8 A junction flexible wiring circuit board according to Claim 7, wherein said metal layer is formed substantially uniformly in the lengthwise direction except portions where the terminal portions are provided.

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